SUNTSU

Multilayer Ceramic Low Pass Filter

SRFLF-3E3DF-ISB7

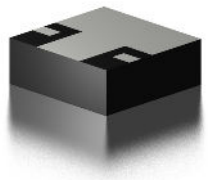
3.4mm x 3.3mm

Features

- Miniature Footprint
- Low Insertion Loss
- High Attenuation on Harmonic Suppressed
- LTCC Process

Applications

- 915MHz Center Frequency
- ISM Band



Part Numbering Guide

S RF LF - 3E3D F - IS B7

SUNTSU	RF COMPONENT	LOW PASS FILTER	PACKAGE SIZE*	* INSERT LOSS (dB)	APPLICATION	FREQUENCY BAND
			3E3D = 3.4mm x 3.3mm	F = 0.5dB	IS = ISM	B7 : 900-930

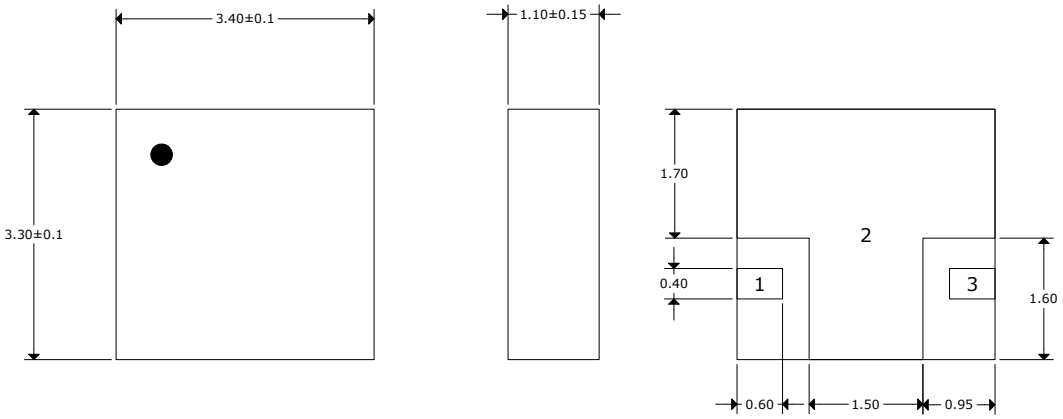
RoHS COMPLIANT

* Where letters denote decimal location (A=.0, B=.1, C=.2, etc.); e.g. B5=0.15, 3A5=3.05, 9A=9.0

Electrical Parameters	Units	Minimum	Typical	Maximum	Remarks
Frequency	MHz	900	915	930	
Insertion Loss @ 25°C	dB			0.5	
VSWR	dB			1.6	
Impedance	Ω		50		
Power Capacity	W			2	
Operating Temperature Range	°C	-40		85	
Storage Temperature Range	°C	-40		85	
Attenuation @ 1.7~1.8GHz	dB	35			
Attenuation @ 3 X fo	dB	30			
Attenuation @ 4 X fo	dB	40			
Attenuation @ 5 X fo	dB	40			

Outline Drawing

All dimensions are in millimeters (mm) unless otherwise noted. Drawings are not to scale.



PIN	FUNCTION
1	Input/Output
2	GND
3	Input/Output

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Specifications are subject to change without notice.

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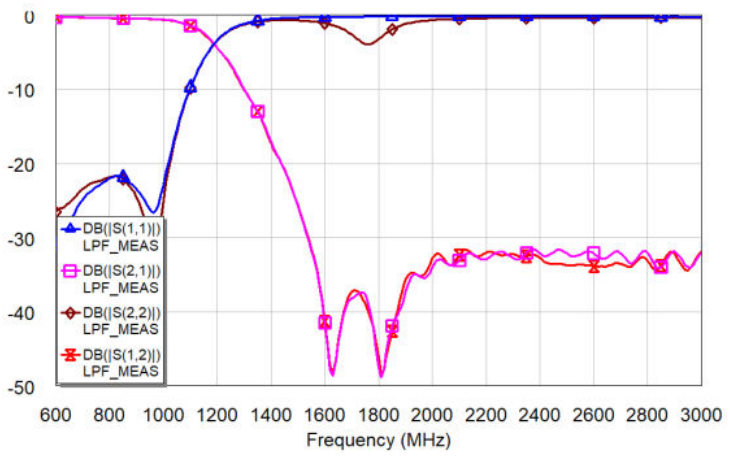
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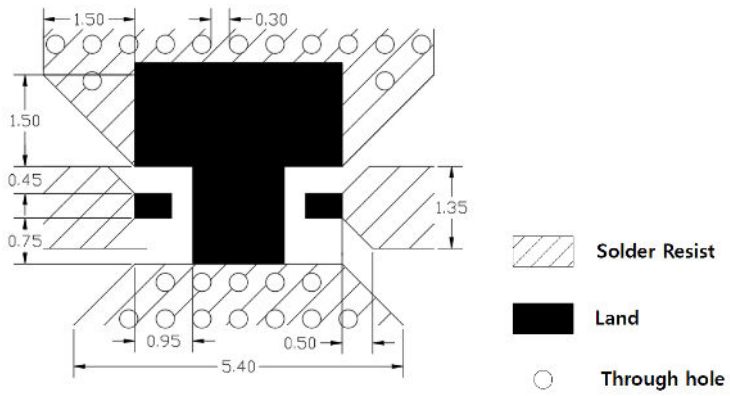
3.4mm x 3.3mm

Typical Electrical Chart



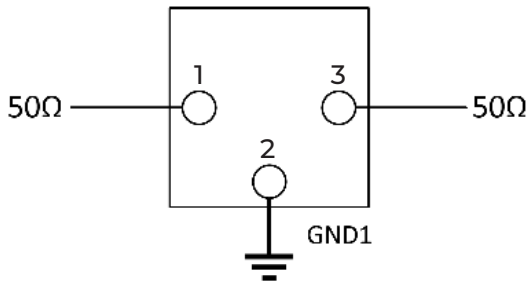
Land Pattern

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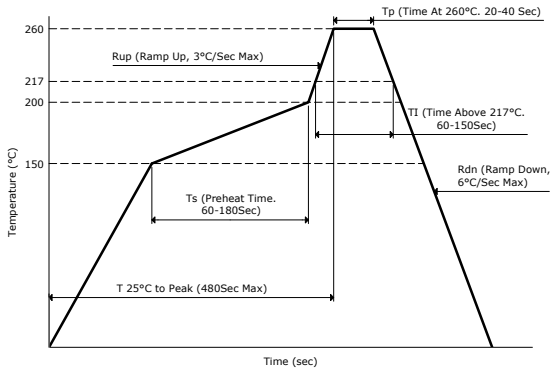


Line width to be designed to match 50Ω characeristic impedance, depending on PCB material and thickness.

Test Circuit



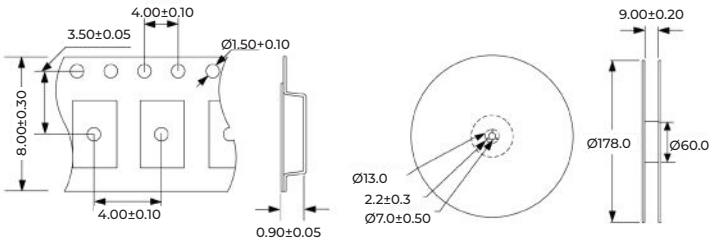
Reflow Profile



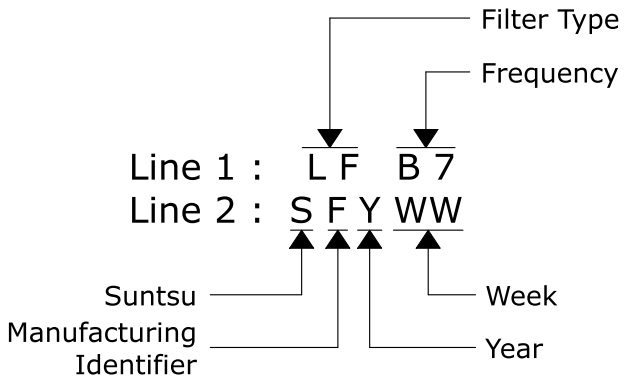
Tape and Reel Dimensions

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3,000 pcs/reel



Markings



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Reliability Test		
Test Item	Test Conditions/Test Method	Specification
Solderability **JIS C 0050-4.6** **JESD22-B1D**	*Solder bath temperature : 235±5°C *Immersion time : 2±0.5 sec Solder : Sn^3Ag 0.5Cu for lead-free	At least 95% of a surface of each terminal electrode must be covered by fresh solder.
Leaching (Resistance to dissolution of metallization) **IEC 60068-2-58**	*Solder bath temperature : 260±5°C *Leaching immersion time : 30±0.5 sec Solder : SN63A	Loss of metallization on the edges of each electrode shall not exceed 25%
Resistance to soldering heat **JIS C 0050-5.4**	*Preheating temperature : 120~150°C, 1 minute *Solder temperature : 270±5°C *Immersion time : 10±1 sec Solder : Sn3Ag 0.5Cu for lead-free Measurement to be made after keeping at room temperature for 24±2 hrs.	No mechanical damage. Eletrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature ranger within -40~85°C. Loss of metallization on the edges of each electrode shall not exceed 25%
Drop Test **JIS C 0044**	*Height : 75 cm *Test surface : Rigid surface of concrete or steel. *Times : 6 surfaces for each unit; 2 times each side.	No mechanical damage. Electrical specification shall satisfy the description in electrical characteristics under the operational temperature range within -40~85°C.
Vibration **JIS C 0040**	*Frequency : 10Hz~55Hz~10Hz (1 min) *Total amplitude : 1.5mm *Test times : 6hrs (two hrs each in three mutually perpendicular directions)	No mechanical damage. Eletrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40~85°C.
Adhesive Strength of Termination **JIS C 0051-7.4.3**	*Pressurizing force : 5N(≤603) ; 10N(>0603) *Test time : 10±1 sec	No remarkable damage or removal of the termination
Bending Test **JIS C 0051-7.4.1**	The middle part of substrate shall be pressurized by means of the pressurizing rod at a rate of about 1mm/s per second until the deflection becomes 1mm/s and then pressure shall be maintained for 5±1 sec. Measurement to be made after keeping at room temperature for 24±2 hours.	No mechanical damage. Eletrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40~85°C.
Temperature Cycle **JIS C 0025**	1. 30±3 minutes at -40°C±3°C 2. 10~15 minutes at room temperature 3. 30±3 minutes at 85°C±3°C 4. 10~15 minutes at room temperaure Total 100 continuous cycles Measurement to be made after keeping at room temperature for 24±2 hous.	No mechanical damage. Eletrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40~85°C.
High Temperature **JIS C 0021**	*Temperature : 85°C±2°C *Test duration : 1000+24/-0 hours Measurement to be made after keeping at room temperature for 24±2 hours.	No mechanical damage. Eletrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40~85°C.
Humidity (steady conditions) **JIS C 0022**	*Humidity : 90% to 95% Relative Humidity *Temperature : 40°C±2°C *Time : 1000+24/-0 hours Measurement to be made after keeping at room temperature for 24±2 hours. **500hrs measuring the first data then 1000hrs data	No mechanical damage. Eletrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40~85°C.
Low Temperature **JIS C 0020**	*Temperature : -40°C±2°C *Test duration : 1000+24/-0 hours Measurement to be made after keeping at room temperature for 24±2 hours.	No mechanical damage. Eletrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40~85°C.

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